

Application No. 10/069,026  
Amdt. dated November 19, 2004  
Reply to Office Action of May 20, 2004

**Amendments to the Abstract:**

Please insert the following Abstract of the Disclosure:

--A method for manufacturing labels (2) for placement in a mold, in particular in an injection mold, wherein a strip of film (4) is supplied and is placed, by at least a part of a first side thereof, on a supporting carrier (6), whereafter a retaining element (14) is applied to, in particular slightly pressed upon, the second side, remote from the carrier (6), of the part of the film web (4) supported by the carrier (6), wherein the part of the film web (4) enclosed between the carrier (6) and the retaining element (14) is cut loose, and wherein the enclosed part, to be referred to as label (2), is taken hold of by the retaining element (14) and is picked up from the carrier (6) therewith.--